

Title (en)
METALLIC FOIL NAIL APPLIQUÉS

Title (de)
METALLFOLIENNAGELAPPLIKATION

Title (fr)
APPLIQUÉS D'ONGLE À FEUILLE MÉTALLIQUE

Publication
EP 2836095 B1 20170607 (EN)

Application
EP 13774972 A 20130409

Priority

- US 201261621887 P 20120409
- US 201361799386 P 20130315
- US 2013035817 W 20130409

Abstract (en)
[origin: WO2013155094A1] A multi-layered foil appliqué for decorating nails is cut from a laminated sheet having the following layers: a first adhesive layer residing on a releasable substrate; a base coat residing on the first adhesive layer; a UV-curable adhesive layer residing on the base coat; a foil layer residing on the UV-curable adhesive layer; and a top coat residing on the foil layer. The foil is applied to the UV-curable adhesive layer by contact between the metallic side of a metallized plastic sheet and the adhesive before the adhesive is cured. The bottom coat and top coat are formed from organic solvent-based nail enamels. Sufficient solvent remains in the appliqué to keep it stretchable before use. Residual solvent evaporates after the appliqué is applied to a user's nail.

IPC 8 full level
A45D 31/00 (2006.01); **B44C 3/02** (2006.01); **G09F 3/02** (2006.01); **G09F 3/10** (2006.01)

CPC (source: EP KR)
A45D 29/001 (2013.01 - KR); **A45D 31/00** (2013.01 - EP KR); **B44C 1/105** (2013.01 - KR); **B44C 1/14** (2013.01 - KR); **B44C 3/02** (2013.01 - EP)

Cited by
US2022232945A1; GB2615032A; CN116490096A; AU2021374933B2; GB2615032B; AU2023263533B2; EP4374736A3; WO2022098883A1; US11641920B2; US12082676B2

Designated contracting state (EPC)
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DOCDB simple family (publication)
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